

01-18-01

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EXPRESS MAIL No. EK 215 866 485 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application
 "Bonding Pad for Flip-Chip Fabrication"
 Case Aralight-1

JCS11 U.S. PTO
 09/761886
 01/17/01

THE COMMISSIONER OF PATENTS AND TRADEMARKS
 WASHINGTON, D.C. 20231

Sir:

Enclosed are the following papers relating to the above-named application for patent:

Specification, 14 pages, including 17 claims
 Seven informal sheets of drawings
 Declaration and Power of Attorney, FAX copies

CLAIMS AS FILED				
	No. Filed	No. Extra	Rate	Calculations
Total Claims	17		x \$18 =	0
Independent Claims	4	1	x \$80 =	80
Multiple Dependent Claims, If Applicable			\$230 =	
Basic Fee				\$ 710
				TOTAL FEE \$ 790.00

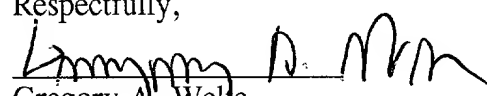
A check for \$ 790.00 is enclosed. Duplicate copies of this letter are enclosed.

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However, telephone calls should be made to Gregory A. Welte (317) 296 - 4699.

Respectfully,


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 January 17, 2001

JCS945 U.S. PTO
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